

**Vishay Siliconix** 

## Dual N-Channel 20 V (D-S) MOSFET

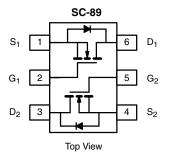
PRODU	CT SUMMARY		
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)
	0.396 at V <sub>GS</sub> = 4.5 V	0.5	
20	0.456 at V <sub>GS</sub> = 2.5 V	0.2	0.75
20	0.546 at V <sub>GS</sub> = 1.8 V	0.2	0.75
	0.760 at V <sub>GS</sub> = 1.5 V	0.05	

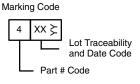
#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Gate-Source ESD Protected: 1000 V
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Load/Power Switching for Portable Devices
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, • Memories
- **Battery Operated Systems** •
- Power Supply Converter Circuits •





Ordering Information: Si1034CX-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b>	(T <sub>A</sub> = 25 °C, un	less otherwis	se noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 8	v	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	I_	0.61 <sup>a, b</sup>		
Continuous Drain Current $(T_J = 150^{\circ}C)^{\circ}$	T <sub>A</sub> = 70 °C	- <sup>I</sup> D	0.49 <sup>a, b</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	2		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	0.18 <sup>a, b</sup>	А	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.22 <sup>a, b</sup>	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	U U	0.14 <sup>a, b</sup>	vv	
Operating Junction and Storage Temperature Ran	ge	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Тур.	Max.	Unit
Maximum Junction-to-Ambient <sup>b</sup>	t ≤ 5 s	R <sub>thJA</sub>	470	565	°C/W
Maximum Sunction-to-Ambient	Steady State	· INJA	560	675	6/11

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 5 s.

FREE

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# Si1034CX

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μΑ		17		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = 250 μA		- 1.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	0.4		1	V	
Gate-Source Leakage		$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 30		
Cale-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$			± 1		
Zero Gate Voltage Drain Current	1	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gale Vollage Dialit Current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			3		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	2			А	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.5 A		0.330	0.396	Ω	
Drain-Source On-State Resistance <sup>a</sup>	D	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 0.2 A		0.380	0.456		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 0.2 A		0.420	0.546		
		V <sub>GS</sub> = 1.5 V, I <sub>D</sub> = 0.05 A		0.505	0.760		
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.5 A		7.5		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			43			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		14		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			8			
Total Cata Charge	0	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 8 \text{ V}, \text{ I}_{D} = 0.6 \text{ A}$		1.3	2		
Total Gate Charge	Qg			0.75	1.2	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 10 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 0.6 A		0.15			
Gate-Drain Charge	Q <sub>gd</sub>			0.13			
Gate Resistance	Řg	f = 1 MHz	2.4	12.2	24.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			11	20		
Rise Time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = 10 \; V, \; R_{L} = 20 \; \Omega \\ I_{D} \cong 0.5 \; A, \; V_{GEN} = 4.5 \; V, \; R_{g} = 1 \; \Omega \end{array}$		16	24	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			26	39		
Fall Time	t <sub>f</sub>			11	20		
Drain-Source Body Diode Characterist	ics				1		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				2	А	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 0.5 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-		10	15	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			2	4	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 0.5 A, dI/dt = 100 A/μs		5			
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

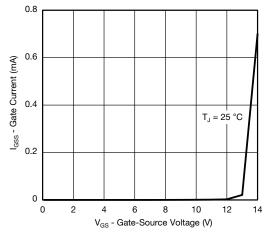
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

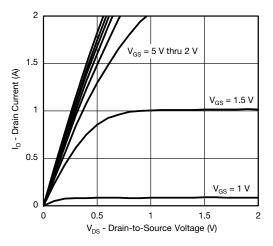
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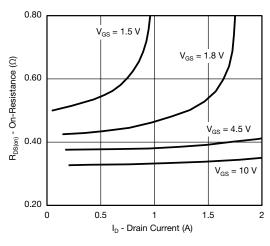
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



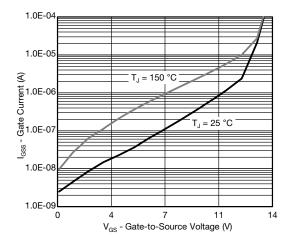




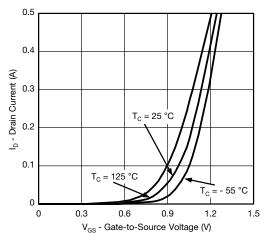
**Output Characteristics** 



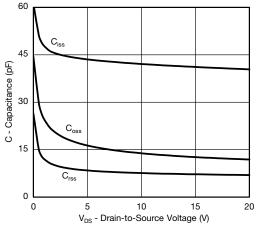
**On-Resistance vs. Drain Current** 



Gate Current vs. Gate-Source Voltage



**Transfer Characteristics** 



Capacitance

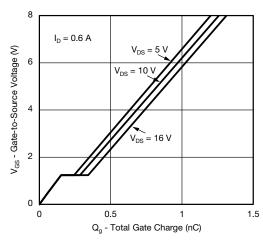
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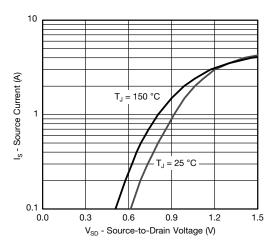
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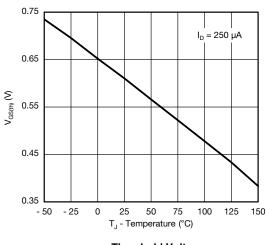
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



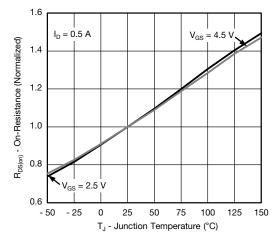
Gate Charge



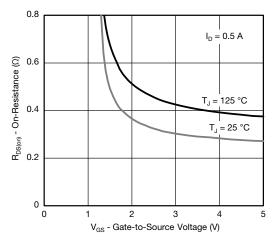
Soure-Drain Diode Forward Voltage



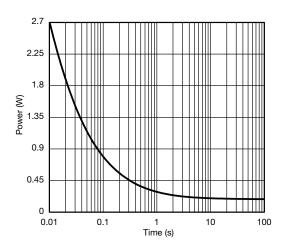
**Threshold Voltage** 



**On-Resistance vs. Junction Temperature** 



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

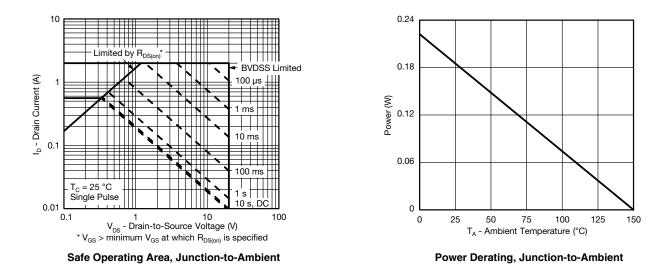
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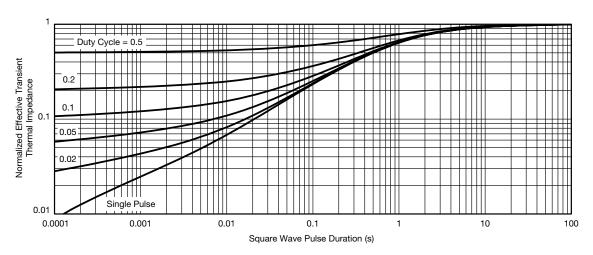


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



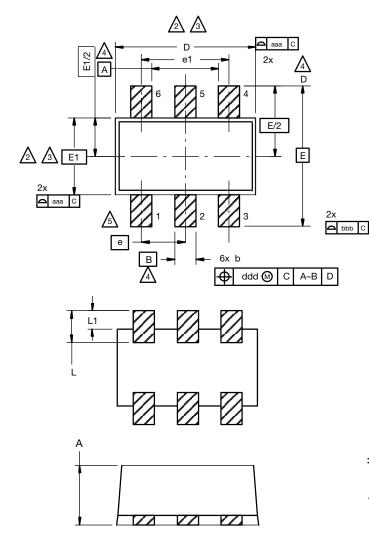
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?67468">www.vishay.com/ppg?67468</a>.



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## SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

 $\triangle$  Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS				
	MIN.	NOM.	MAX.		
А	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14				

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

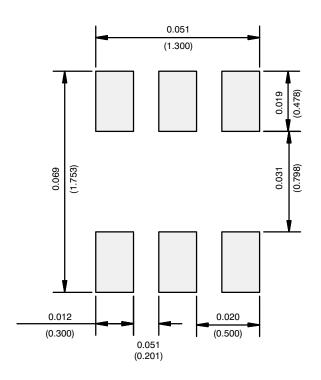
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# Application Note 826

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#### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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